

CG10 Series

Gas Discharge Tubes



Web Resources



Download ECAD models, order samples, and find technical resources at www.littelfuse.com

Agency Approvals

Agency	Agency File Number
	E1286621
	E320116 ²

Notes:

1. Certified to UL 497B.
2. Certified to UL 1449.

Description

Littelfuse's highly reliable CG10 Series GDTs provide a high surge capability in a small size ideal for board level circuit protection. GDTs function as switches which dissipate a minimum amount of energy and therefore handle currents that far surpass other types of transient voltage protection. Their gas-filled, rugged ceramic metal construction make them well suited to adverse environments.

The CG10 series comes different forms including surface mount, straight leads, to serve a variety of mounting methods.

Features

- High surge current rating
- Rugged ceramic-metal construction
- Low Capacitance (<1.0 pf)
- High operating temperature up to 125 °C
- Available in surface mount, and straight leads options
- RoHS Compliant and Lead-free

Applications

- Communication lines and equipment
- CATV equipment
- Test equipment
- Data lines
- Power supplies
- Instrumentation circuits
- Medical electronics
- ADSL equipment
- Telecom SLIC protection
- Alarm system

Two Electrode GDT Graphical Symbol



Electrical Characteristics

Part Number	Device Specifications (at 25 °C)						Life Rating					
	DC Breakdown in Volts (@ 100 V/s)			Impulse Break-down In Volts (@ 100 V/μs)	Impulse Break-down In Volts (@ 1 kV/μs)	Insulation Resistance	Capacitance (@ 1 MHz)	Arc Voltage (on state Voltage) @ 1Amp Min	Surge Life (@ 100A 10/1000μs)	Nominal Impulse Discharge Current (8/20μs)	Nominal AC Discharge Current (10x1sec @ 50Hz)	Max Impulse Discharge Current (1 Application @ 10/350 μs)
	MIN	TYP	MAX			MIN		TYP				
CG1090	72	90	108	500	600		<1 pF	10 V	300 shots	10 shots (@20 kA)	10 A	2.5 kA
CG10230	184	230	276	550	650	10 ¹⁰ Ω at 50VDC	<1 pF	10 V	300 shots	10 shots (@20 kA)	20 A	2.5 kA
CG10350	280	350	420	700	900		<1 pF	10 V	300 shots	10 shots (@20 kA)	20 A	2.5 kA
CG10470	376	470	564	1000	1100	10 ⁹ Ω at 100VDC	<1 pF	10 V	300 shots	10 shots (@20 kA)	20 A	2.5 kA
CG10600	480	600	720	1100	1400	10 ¹⁰ Ω at 100VDC	<1 pF	10 V	300 shots	10 shots (@20 kA)	20 A	2.5 kA
CG10800	640	800	960	1300	1500	10 ¹⁰ Ω at 100VDC	<1 pF	10 V	300 shots	10 shots (@20 kA)	20 A	1.5 kA
CG101000	800	1000	1200	1400	1500	10 ⁹ Ω at 100VDC	<1 pF	30 V	–	10 shots (@10 kA), 1 shot (@15 kA)	10 A	–

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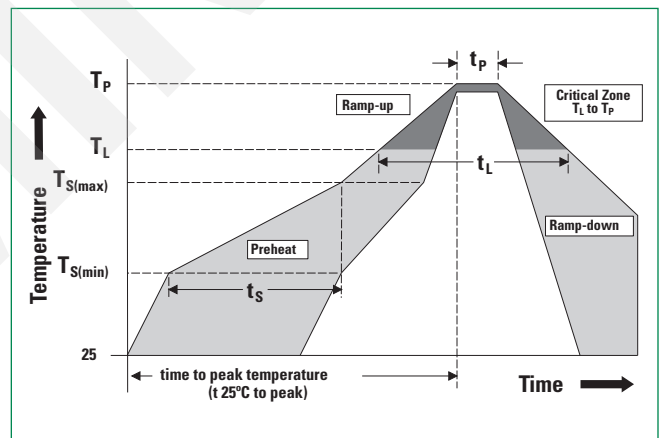
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Product Characteristics

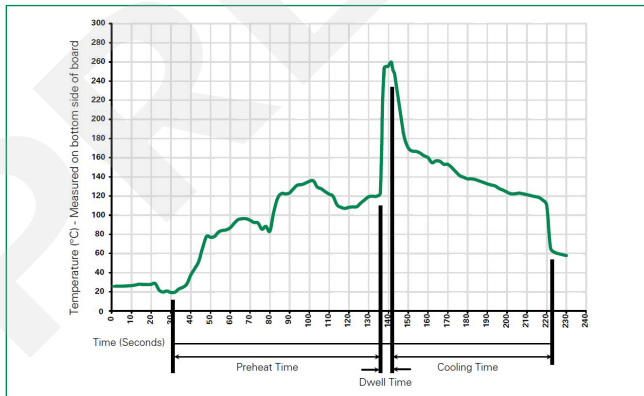
Materials	LTR, Axial Device: 17.5±12.5 Microns Lead Wires: 6-9 Microns SM, SMD Device: 17.5±12.5 Microns
Operating & Storage Temperature	-40 °C to 125 °C
Product Marking	LF Logo, Voltage and date code; Black ink positive print
Glow to arc transition current	<0.5 Amps
Glow Voltage	65 to 180 Volts
Storage & Operational Temperature	-40 to +125

Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Condition		Pb-free assembly
Number of allowed reflow cycles		3
Pre Heat	- Temperature Min ($T_{s(min)}$)	150 °C
	- Temperature Max ($T_{s(max)}$)	200 °C
	- Time (Min to Max) (t_s)	60–180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak		3 °C / second max.
$T_{S(max)}$ to T_L - Ramp-up Rate		3 °C / second max.
Reflow	- Temperature (T_L) (Liquidus)	217 °C
	- Temperature (t_L)	60–150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		10 – 30 seconds
Ramp-down Rate		6 °C / second max.
Time 25 °C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260 °C



Soldering Parameters: Wave Soldering (Thru-Hole Devices)



Wave Parameter	Lead-Free Recommendation
Preheat: (Depends on Flex Activation Temperature)	(Typical Industry Recommendation)
Temperature Minimum	100 °C
Temperature Maximum	150 °C
Preheat Time	60–180 seconds
Solder Pot Temperature	280 °C Maximum
Solder Dwell Time	2–5 seconds

Recommended Hand-Solder Parameters:

Solder Iron Temperature: 350 °C +/- 5 °C

Heating Time: 5 seconds max.

Note: These devices are not recommended for IR or Convection Reflow process.

Soldering Parameters: Hand Soldering

Solder Iron Temperature: 350 °C +/- 5 °C

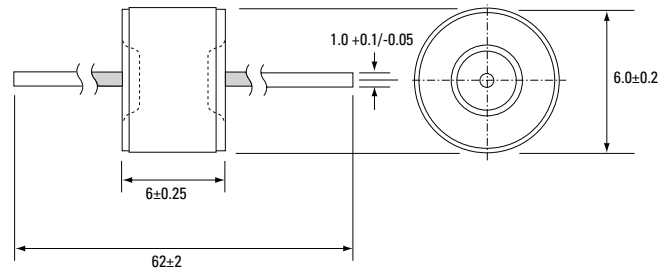
Heating Time: 5 seconds max.

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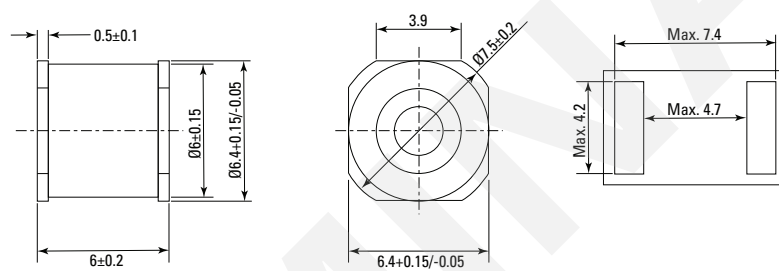
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Device Dimensions

Leaded LTR Type Straight Axial Devices

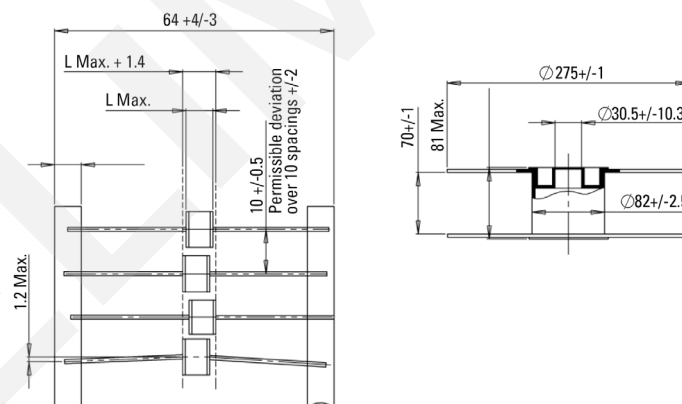


SM Type Devices



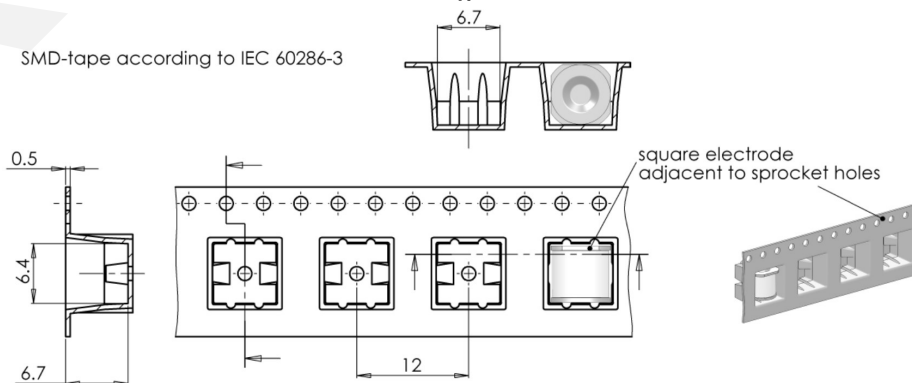
Packaging Dimensions

For LTR Type Axial Lead Items



For SM Type Items

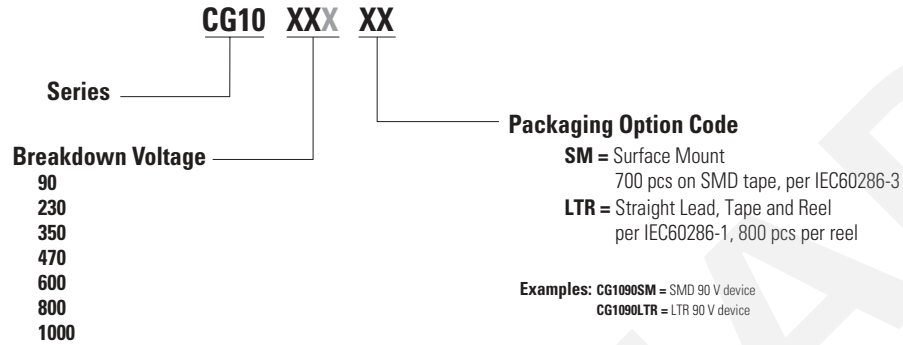
SMD-tape according to IEC 60286-3



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Part Numbering System and Ordering Information



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